

Thick Film Chip Resistor Array

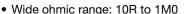


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The CRA04S thick film resistor array is constructed on a high grade ceramic body with convex terminations. A small package enables the design of high density circuits. The single component reduces board space, component counts, and assembly costs.

FEATURES

Convex terminal array with square corners





ROHS

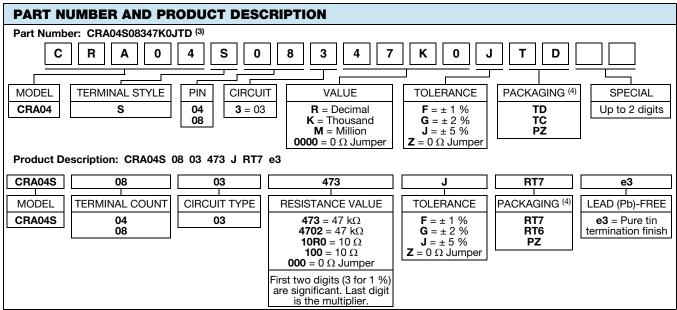
- 4 or 8 terminal package with isolated resistors
- · Lead (Pb)-free solder contacts on Ni barrier layer
- Pure tin plating provides compatibility with lead (Pb)-free and lead containing soldering processes
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

STANDARD ELECTRICAL SPECIFICATIONS								
MODEL			TEMPERATURE COEFFICIENT ± ppm/K	TOLERANCE ± %	RESISTANCE RANGE Ω	E-SERIES		
CRA04S	03	0.063	50	100	1	10 to 1M	24 + 96	
			50	200	2; 5	10 to 1101	24	
		Zero-Ohm-Resistor: $R_{\text{max.}} \le 50 \text{ m}\Omega$, $I_{\text{max.}} = 1 \text{ A}$						

TECHNICAL SPECIFICATIONS						
PARAMETER	UNIT	CRA04S				
Rated dissipation at 70 °C (2)	W per element	0.063				
Limiting element voltage (1)	V≅	50				
Insulation voltage (1 min)	V _{DC/AC peak}	100				
Category temperature range	°C	- 55 to + 155				
Insulation resistance	Ω	> 10 ⁹				

Notes

- (1) Rated voltage: $\sqrt{P \times R}$.
- (2) The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rate dissipation applies only if the permitted film temperature of 155 °C is not exceeded.



Notes

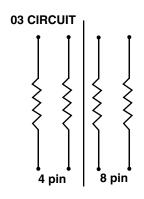
- (3) Preferred way for ordering products is by use of the PART NUMBER.
- (4) Please refer to the table PACKAGING, see next page.



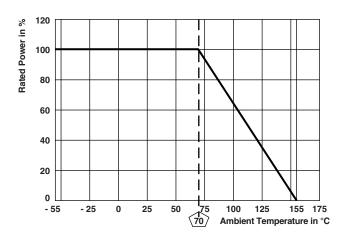


PACKAGING							
			PITCH	PIECES/REEL	PACKAGING CODE		
MODEL	TAPE WIDTH	DIAMETER			PAPER TAPE		
					PART NUMBER	PRODUCT DESCRIPTION	
		180 mm/7"	2 mm	10 000	TD	RT7	
CRA04S	8 mm	330 mm/13"	2 mm	20 000	TC	RT6	
		330 mm/13"	2 mm	50 000	PZ	PZ	

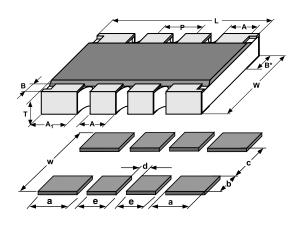
CIRCUIT



DERATING



DIMENSIONS



PIN	DIMENSIONS in millimeters							
NO #	L	Α	A ₁	В	B*	P _{NOM} .	T	W
4	1.0 ± 0.1	-	0.33	0.15	0.25	0.65	0.35	1.0
8	2.0 ± 0.2	0.30	0.4	0.15	0.25	0.50	0.45	1.0
TOL.	-	± 0.15	± 0.15	± 0.10	± 0.1	-	± 0.1	± 0.15

SOLDER PAD DIMENSIONS in millimeters							
c w d a b e							
WAVE	0.45	1.45	0.2	0.4	0.5	0.3	

The dimensions shown are for a 8 pin part. For parts with different pin numbers use the same pitch and add or substract pads as required.



TEST PROCEDURES AND REQUIREMENTS							
EN 60115-1							
TEST	CONDITIONS OF TEST	REQUIREMENTS PERMISSIBLE CHANGE ($\Delta R/R$) (1)					
(clause)	CONDITIONS OF TEST	STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER				
	Stability for product types:	10 Ω to 1 MΩ 10 Ω to 1 MΩ					
	CRA04S	10.22.00.1.10122	10 22 10 1 10122				
Resistance (4.5)	-	± 1 %	± 2 %; ± 5 %				
Temperature coefficient (4.8.4.2)	(20/- 55/20) °C and (20/125/20) °C	± 100 ppm/K	± 200 ppm/K				
Overload (4.13)	$U = 2.5 \times (P_{70} \times R)^{1/2}$ $\leq 2 \times U_{\text{max.}}; 0.5 \text{ s}$	± (0.25 % R + 0.05 Ω)	± (0.5 % R + 0.05 Ω)				
Solderability (4.17.5) (2)	Aging 4 h at 155 °C, dryheat solder bath method; 235 °C; 2 s visual examination	Good tinning (≥ 95 % covered) no visible damage					
Resistance to soldering heat (4.18.2)	Solder bath method; (260 ± 5) °C; (10 ± 1) s	± (0.25 % R + 0.05 Ω)	± (0.5 % R + 0.05 Ω)				
Rapid change of temperature (4.19)	30 min at LCT = - 55 °C; 30 min at UCT = 125 °C; 5 cycles	± (0.25 % R + 0.05 Ω)	$\pm (0.5 \% R + 0.05 \Omega)$				
Damp heat, steady state (4.24)	(40 ± 2) °C; 56 days; (93 ± 3) % RH	± (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)				
Climatic sequence (4.23)	16 h at UCT = 125 °C; 1 cycle at 55 °C; 2 h at LCT = -55 °C; 1 h/1 kPa at 15 °C to 35 °C; 5 cycles at 55 °C $U = (P_{70} \times R)^{1/2}$ $U = U_{\text{max.}}$; whichever is less severe	± (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)				
Endurance at 70 °C (4.25.1)	$U = (P_{70} \times R)^{1/2}$ $U = U_{\text{max.}}$; whichever is less severe 1.5 h "ON"; 0.5 h "OFF"; 70 °C; 1000 h	± (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)				
Extended endurance (4.25.1.8)	Duration extended to 8000 h	± (2 % R + 0.1 Ω)	± (4 % R + 0.1 Ω)				
Endurance at upper category temperature (4.25.3)	UCT = 125 °C; 1000 h	± (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)				

Notes

APPLICABLE SPECIFICATIONS

EN 60115-1 Generic specification
EN 140400 Sectional specification
EN 140401-802 Detail specification
IEC 60068-2-X Variety of environmental test procedures
EIA 481 Packaging of SMD components

⁽¹⁾ Figures are given for a single element.

⁽²⁾ Solderability is specified for 2 years after production or requalification. Permitted storage time is 20 years.



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